FETek Technology Corp.

P-Ch 60V Fast Switching MOSFETs

★ 100% EAS Guaranteed
★ Green Device Available
★ Super Low Gate Charge
★ Excellent CdV/dt effect decline
★ Advanced high cell density Trench technology

Product Summary

BVDSS	RDSON	ID
-60V	70mΩ	-15A

Description

The FKF6103 is the high cell density trenched P-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The FKF6103 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO220F Pin Configuration
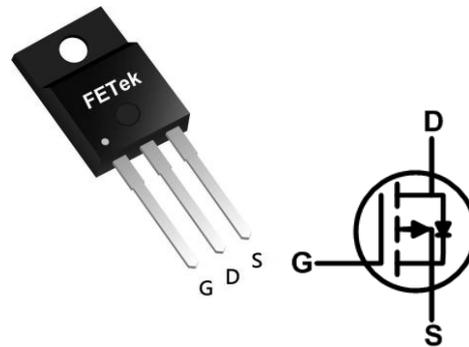
Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_C=25°C	Continuous Drain Current, V_{GS} @ -10V[1]	-15	A
I_D@T_C=100°C	Continuous Drain Current, V_{GS} @ -10V[1]	-9.3	A
I_D@T_A=25°C	Continuous Drain Current, V_{GS} @ -10V[1]	-4.3	A
I_D@T_A=70°C	Continuous Drain Current, V_{GS} @ -10V[1]	-3.5	A
I_{DM}	Pulsed Drain Current[2]	-30	A
EAS	Single Pulse Avalanche Energy[3]	35.4	mJ
I_{AS}	Avalanche Current	-26.6	A
P_D@T_C=25°C	Total Power Dissipation[4]	23	W
P_D@T_A=25°C	Total Power Dissipation[4]	2	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{θJA}$	Thermal Resistance Junction-Ambient [1]	---	62	°C/W
$R_{θJC}$	Thermal Resistance Junction-Case[1]	---	5.4	°C/W

Electrical Characteristics (T$_J$=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV$_{DSS}$	Drain-Source Breakdown Voltage	V$_{GS}$=0V , I$_D$=-250uA	-60	---	---	V
△BV$_{DSS}$/△T$_J$	BV$_{DSS}$ Temperature Coefficient	Reference to 25℃ , I$_D$=-1mA	---	-0.03	---	V/℃
R$_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V$_{GS}$=-10V , I$_D$=-12A	---	---	70	mΩ
		V$_{GS}$=-4.5V , I$_D$=-8A		---	105	
V$_{GS(th)}$	Gate Threshold Voltage	V$_{GS}$=V$_{DS}$, I$_D$ =-250uA	-1.2	---	-2.5	V
△V$_{GS(th)}$	V$_{GS(th)}$ Temperature Coefficient		---	4.56	---	mV/℃
I$_{DSS}$	Drain-Source Leakage Current	V$_{DS}$=-48V , V$_{GS}$=0V , T$_J$=25℃	---	---	1	uA
		V$_{DS}$=-48V , V$_{GS}$=0V , T$_J$=55℃	---	---	5	
I$_{GSS}$	Gate-Source Leakage Current	V$_{GS}$=±20V , V$_{DS}$=0V	---	---	±100	nA
gfs	Forward Transconductance	V$_{DS}$=-5V , I$_D$=-9A	---	15.3	---	S
R$_g$	Gate Resistance	V$_{DS}$=0V , V$_{GS}$=0V , f=1MHz	---	13.5	---	Ω
Q$_g$	Total Gate Charge (-4.5V)	V$_{DS}$=-48V , V$_{GS}$=-4.5V , I$_D$=-10A	---	9.86	---	nC
Q$_{gs}$	Gate-Source Charge		---	3.08	---	
Q$_{gd}$	Gate-Drain Charge		---	2.95	---	
T$_{d(on)}$	Turn-On Delay Time	V$_{DD}$=-15V , V$_{GS}$=-10V , R$_G$=3.3Ω, I$_D$=-1A	---	28.8	---	ns
T$_r$	Rise Time		---	19.8	---	
T$_{d(off)}$	Turn-Off Delay Time		---	60.8	---	
T$_f$	Fall Time		---	7.2	---	
C$_{iss}$	Input Capacitance	V$_{DS}$=-15V , V$_{GS}$=0V , f=1MHz	---	1447	---	pF
C$_{oss}$	Output Capacitance		---	97.3	---	
C$_{rss}$	Reverse Transfer Capacitance		---	70	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I$_S$	Continuous Source Current[1,5]	V$_G$=V$_D$=0V , Force Current	---	---	-15	A
I$_{SM}$	Pulsed Source Current[2,5]		---	---	-30	A
V$_{SD}$	Diode Forward Voltage[2]	V$_{GS}$=0V , I$_S$=-1A , T$_J$=25℃	---	---	-1.2	V

Note :
1.The data tested by surface mounted on a 1 inch[2] FR-4 board with 2OZ copper.
2.The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3.The EAS data shows Max. rating . The test condition is V$_{DD}$=-25V,V$_{GS}$=-10V,L=0.1mH,I$_{AS}$=-26.6A
4.The power dissipation is limited by 150℃ junction temperature
5.The data is theoretically the same as I$_D$ and I$_{DM}$, in real applications , should be limited by total power dissipation.

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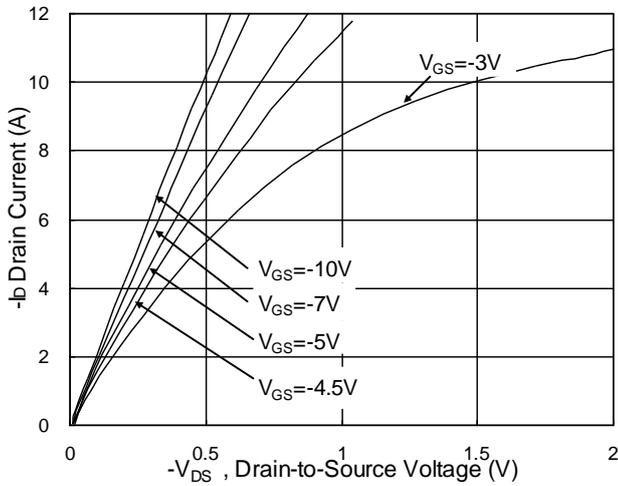## Typical Characteristics

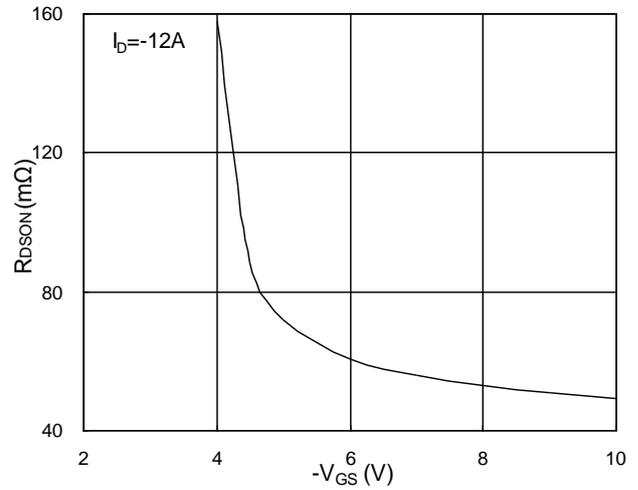**Fig.1 Typical Output Characteristics**
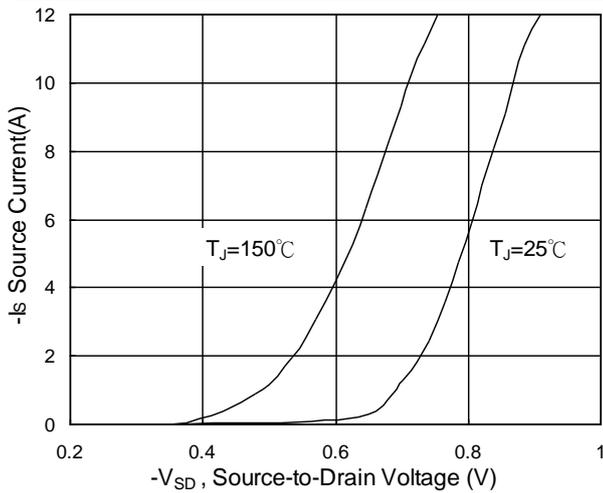
Fig.2 On-Resistance v.s Gate-Source

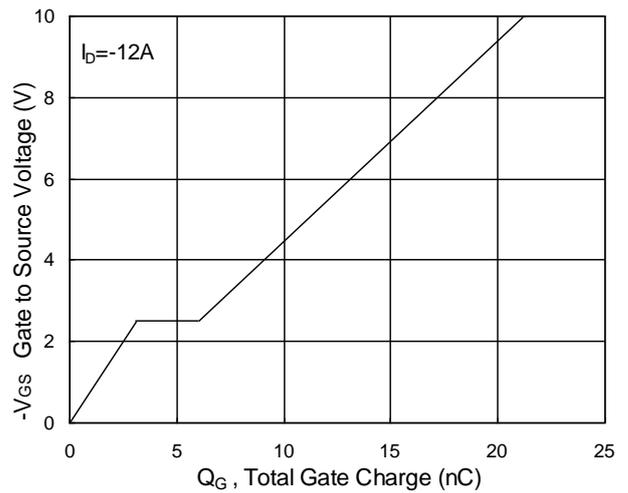**Fig.3 Forward Characteristics of Reverse**
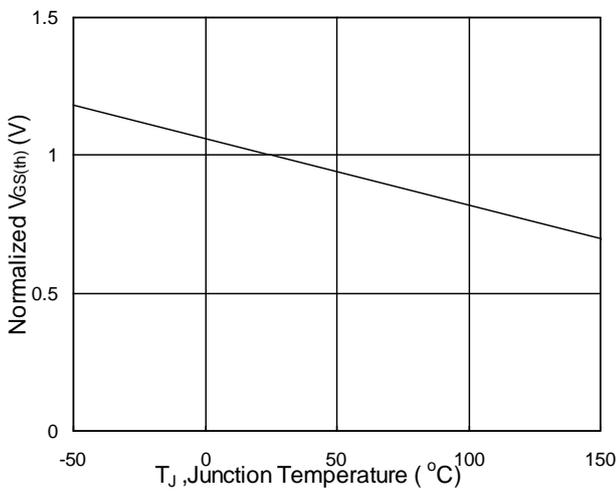
Fig.4 Gate-Charge Characteristics

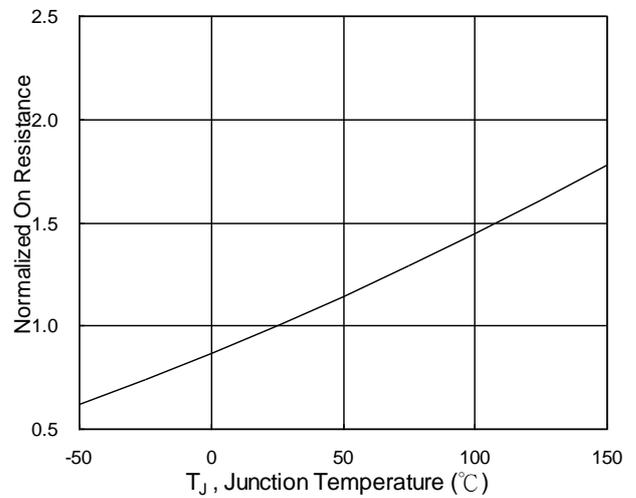**Fig.5 Normalized $V_{GS(th)}$ vs. T_J**

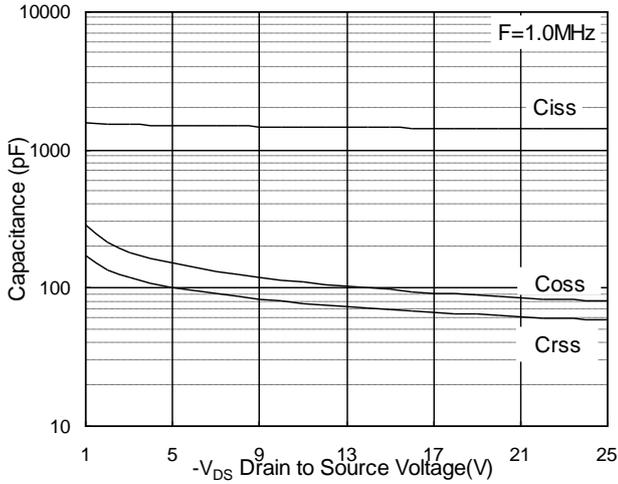**Fig.6 Normalized R_{DSON} vs. T_J**

Fig.7 Capacitance
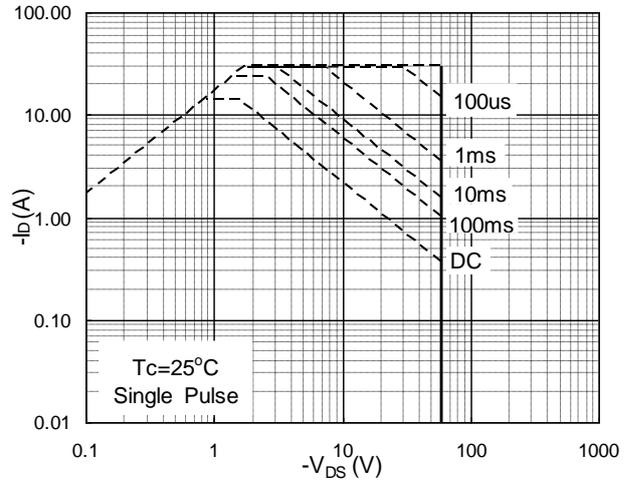
Fig.8 Safe Operating Area
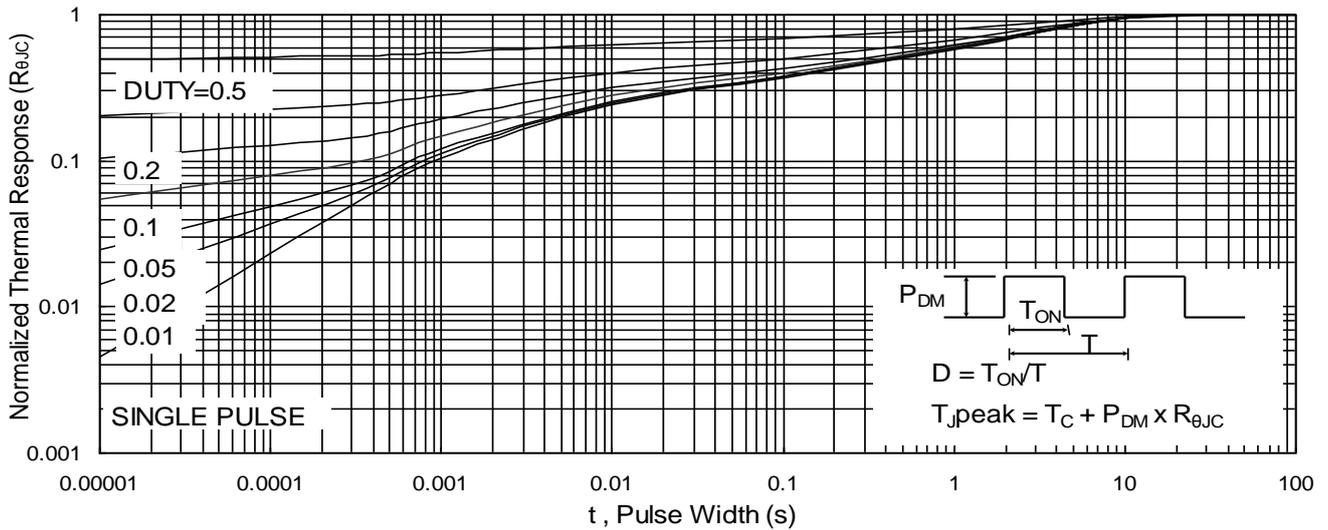
Fig.9 Normalized Maximum Transient Thermal Impedance

$$D = T_{ON}/T$$

$$T_J peak = T_C + P_{DM} \times R_{\theta JC}$$
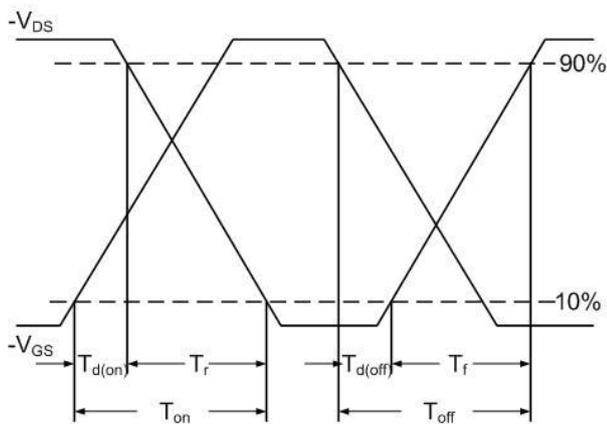
Fig.10 Switching Time Waveform

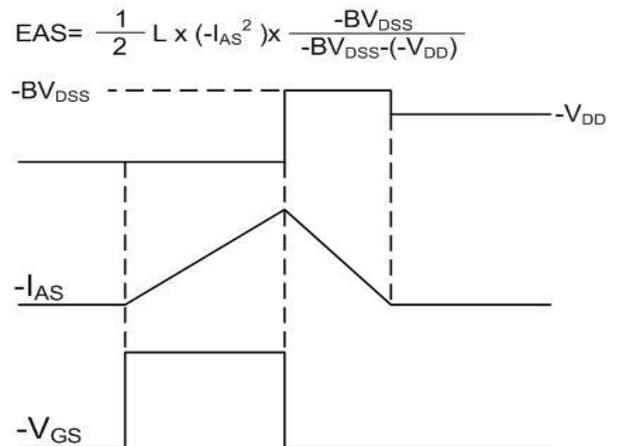$$EAS = \frac{1}{2} L \times (-I_{AS}^2) \times \frac{-BV_{DSS}}{-BV_{DSS}-(-V_{DD})}$$

Fig.11 Unclamped Inductive Waveform